



A Philips Lighting and Agilent Technologies Joint Venture

HSMB-HR00
HSMB-HD00
HSMB-HA00

Technical Data

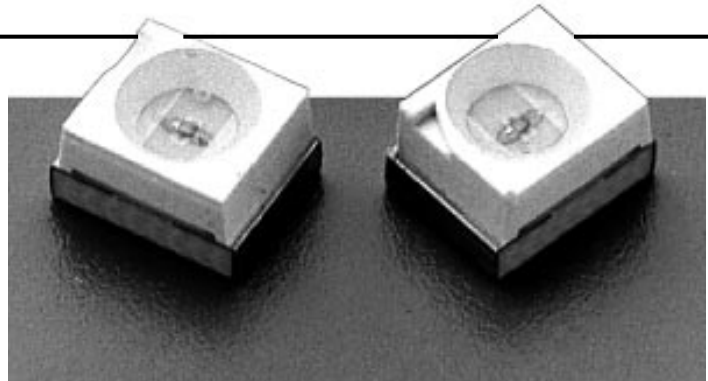
High-Flux Surface Mount LED

Features

- High-Flux Device
- Improved Reliability Through Elimination of Internal Wire Bond
- -55°C to 110°C Operating Temperature Range
- Compatible with IR and Through-the-Wave Solder Processes
- Available in 8 mm Tape on 178 mm (7") Reels; 2000 Pieces per Reel

Applications

- Telltale Backlighting in Instrument Clusters
- Backlighting (LCD, Phones, Switches, Displays, Advertising)
- General Status Indicators
- Coupling into Light Guides
- Passenger Information Panels
- General Information Panels



Description

The HSMB-HX00 device is designed for applications requiring high-flux in surface mount designs. The product is ideal for telltale backlighting in automotive instrument clusters, LCD backlighting, or general status indication. The high light output lowers the cost of lighting by reducing the number of LEDs required for any application.

The HSMB-HX00 combines high reliability surface mount flip-chip LED construction with the world's brightest red and amber LED materials, LumiLed's TS AlInGaP material.

The package is compatible with IR and convective reflow soldering processes. These parts are also compatible with through-the-wave soldering processes.

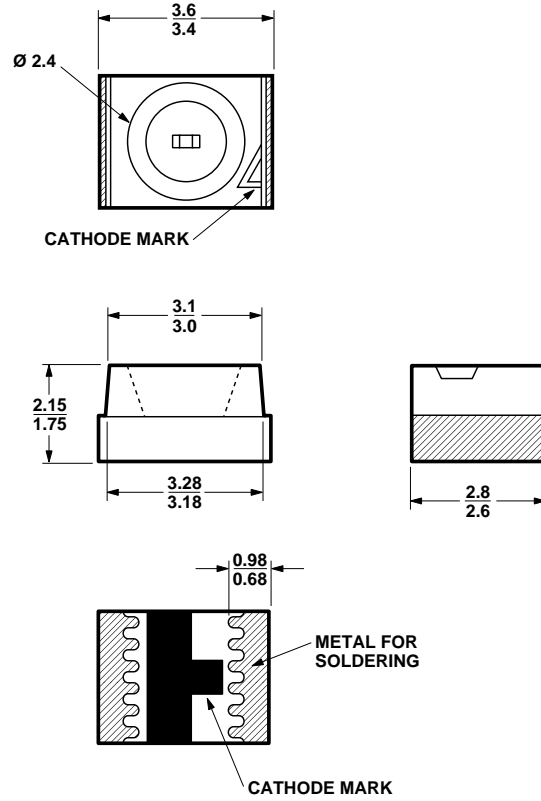
Device Selection Guide

Part Number	Color Typical Dominant Wavelength ^[1] (nm)	Luminous Intensity I _V (mcd) @ I _F = 20 mA Min.	Luminous Intensity I _V (mcd) @ I _F = 20 mA Typ.	Viewing Angle ^[2] (2θ, Degrees)
HSMB-HR00-Q2T20	Red 630	80	180	120
HSMB-HD00-Q2T20	Orange 605	80	220	120
HSMB-HA00-Q1T20	Amber 590	63	200	120

Notes:

1. The dominant wavelength, λ_d , is derived from the CIE Chromaticity Diagram and represents the perceived color of the LED.
2. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 of the peak intensity.

Package Dimensions



ALL DIMENSIONS IN MILLIMETERS

Absolute Maximum Ratings at $T_A = 25^\circ\text{C}$ for HSMB-HR00/HA00/HD00

Parameter	Max. Rating	Units
DC Forward Current ^[1]	30	mA
Power Dissipation ($T_A \leq 70^\circ\text{C}$)	100	mW
Average Forward Current	30	mA
Junction Temperature	125	$^\circ\text{C}$
Reverse Voltage ($I_R = 100 \mu\text{A}$)	5	V
Operating Temperature Range	-55 to 110	$^\circ\text{C}$
Storage Temperature Range	-55 to 110	$^\circ\text{C}$

Note:

1. Derate linearly as shown in Figure 6 for temperatures above 70°C .

Optical Characteristics at T_A = 25°C

Luminous Part Number	Color	Color, Dominant Wavelength ^[1] λ _d (nm) Typ.	Peak Wavelength λ _{peak} (nm) Typ.	Luminous Intensity I _V (mcd) @ I _F = 20 mA Min.	Intensity I _V (mcd) @ I _F = 20 mA Typ.
HSMB-HR00	Red	630	640	80	180
HSMB-HD00	Orange	605	610	80	220
HSMB-HA00	Amber	590	594	63	200

Note:

Optical Characteristics at T_A = 25°C, continued

Part Number	Color	Luminous Flux ^[2] @ 20 mA (lm) Min. Typ.		Luminous Efficiency ^[3] Φ _v /P _{in} (lm/W) Typ.	Viewing Angle ^[4] (2θ _{1/2} , Degrees) Typ.
HSMB-HR00	Red	200	450	10	120
HSMB-HD00	Orange	200	550	11	120
HSMB-HA00	Amber	180	530	11	120

Notes:

2. Luminous flux values are not measured in production.

3. Luminous Efficiency = emitted luminous flux/electrical power input.

4. θ_{1/2} is the off-axis angle where the luminous intensity is 1/2 of the peak intensity.

Electrical Characteristics at T_A = 25°C

Part Number	Color	Forward Voltage V _F (Volts) @ I _F = 20 mA Min.	Forward Voltage V _F (Volts) @ I _F = 20 mA Typ.	Forward Voltage V _F (Volts) @ I _F = 20 mA Max.	Reverse Voltage V _R (Volts) @ I _R = 100 μA Min.
HSMB-HR00	Red	1.70	2.30	3.00	5.0
HSMB-HD00	Orange	1.85	2.40	3.15	5.0
HSMB-HA00	Amber	1.90	2.45	3.20	5.0

Electrical Characteristics at T_A = 25°C, continued

Part Number	Color	Thermal Resistance of Device R _{θJ-PIN} (°C/W)	Thermal Resistance on PC Board (≥ 16 mm ² Pad Size, FR4) R _{θJ-AIR} (°C/W)	Capacitance C (pF) V _F = 0, f = 1 MHz Typ.
HSMB-HR00	Red	280	480	25
HSMB-HD00	Orange	280	480	25
HSMB-HA00	Amber	280	480	25

Intensity Bin Definitions

(Check with LumiLeds Sales Engineer for availability of bin selections)

Bin ID	Intensity (mcd)
Q1	63.0 – 100.0
Q2	80.0 – 125.0
R1	100.0 – 160.0
R2	125.0 – 200.0
S1	160.0 – 250.0
S2	200.0 – 320.0
T1	250.0 – 400.0
T2	320.0 – 500.0

Amber Color Bin Definitions, HSMB-HA00 only

Bin ID	Dominant Wavelength (nm)
B	584.0 – 587.5
C	586.5 – 590.0
D	589.0 – 592.5
E	591.5 – 595.0
F	594.0 – 597.5
0	Bins B through F
1	Bins B and C
2	Bins C and D
3	Bins D and E
4	Bins E and F
5	Bins B, C, and D
6	Bins C, D, and E
7	Bins D, E, and F

Orange Color Bin Definitions, HSMB-HD00 only

Bin ID	Dominant Wavelength (nm)
B	599.0 – 602.5
C	601.5 – 605.0
D	603.8 – 608.2
E	606.8 – 611.2
F	609.8 – 614.2
0	Bins B through F
1	Bins B and C
2	Bins C and D
3	Bins D and E
4	Bins E and F
5	Bins B, C, and D
6	Bins C, D, and E
7	Bins D, E, and F

Color and Intensity Option Codes

(Check with LumiLeds Sales Engineer for availability of bin selections)

HSMB-HX00 XXXXX

— Last digit identifies the color bin option
(use 0 for red as there are no red color bins)

— First four digits identify the min. and max. of
the intensity bins

Examples: HSMB-HA00-Q1T20 designates HSMB-HA00 with a
178 mm reel, no intensity or
color bin selection

HSMB-HA00-R1S23 designates HSMB-HA00 with
178 mm reel, intensity bins R1
through S2, and color bin D and E

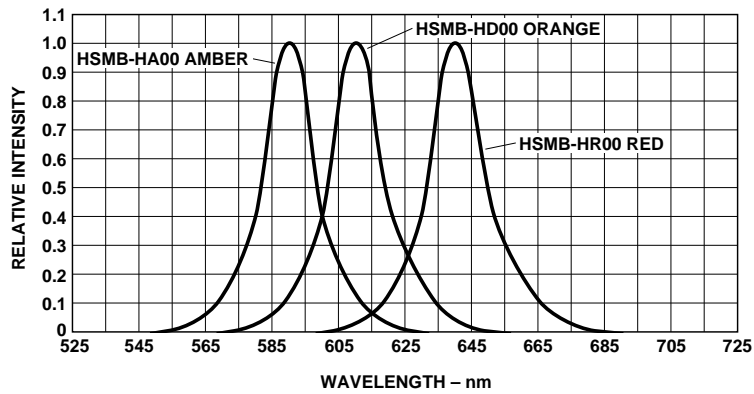


Figure 1. Relative Intensity vs. Wavelength.

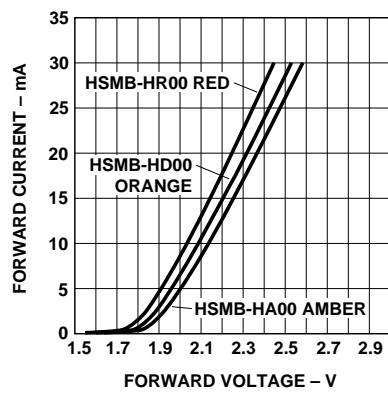


Figure 2. Forward Current vs. Forward Voltage (0 – 30 mA).

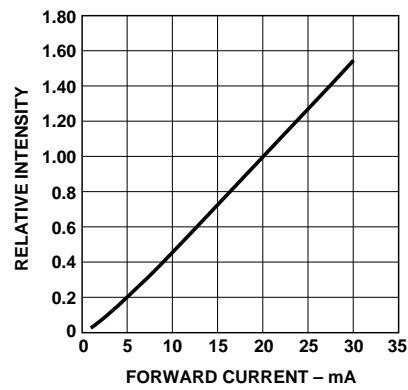


Figure 3. Relative I_V vs. DC Forward Current (Normalized at 20 mA).

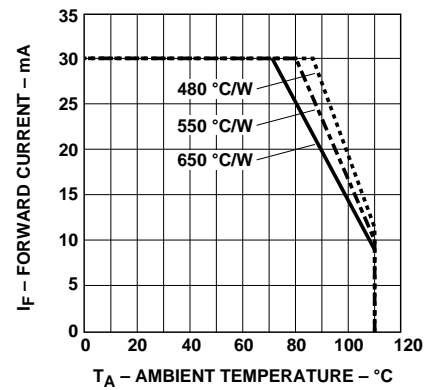


Figure 4. Maximum DC Current vs. Ambient Temperature. (Based on Typical V_F at Max. Current.)

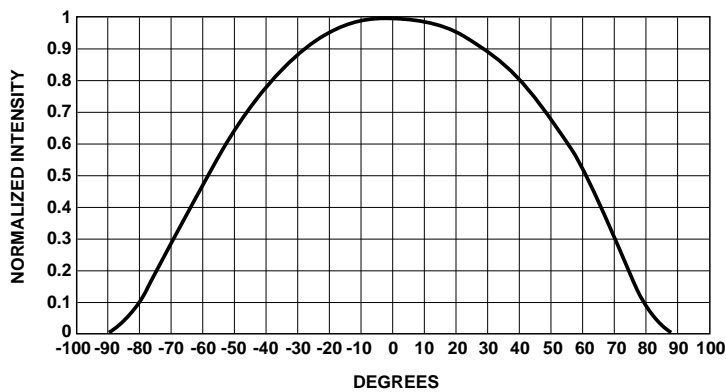


Figure 5. Relative Intensity vs. Angle.

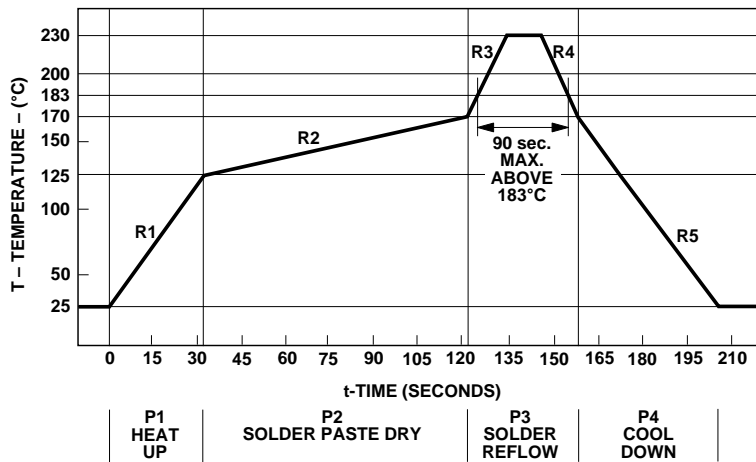


Figure 6. Recommended InfraRed Reflow Soldering Profile.

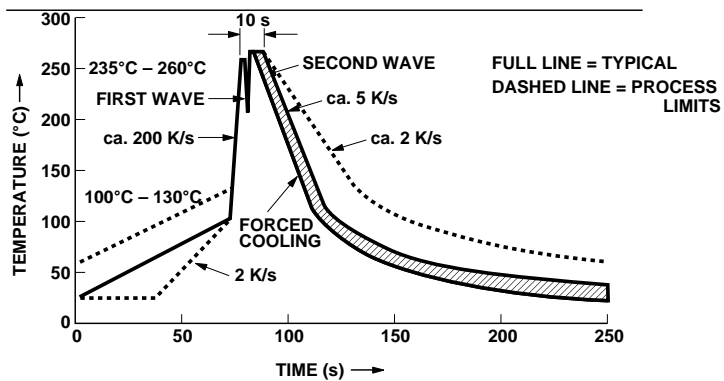


Figure 7. Recommended Wave-Soldering Profile.

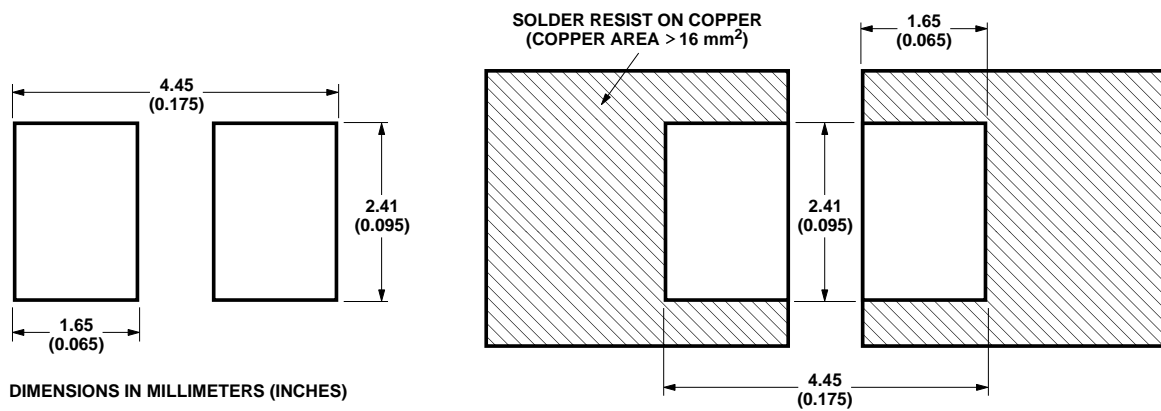


Figure 8. Recommended Solder Pad Dimensions and Pad Design.

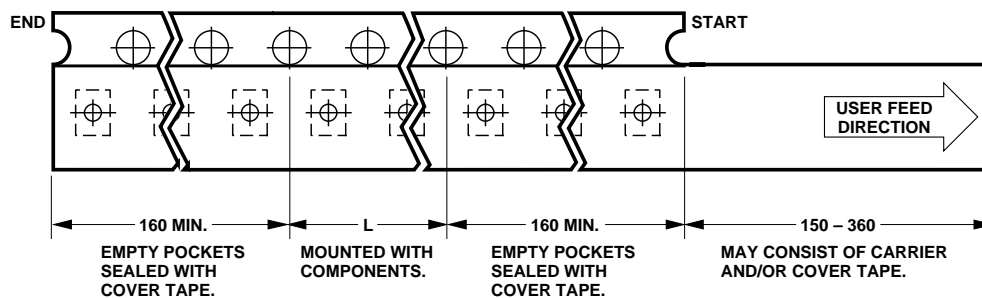
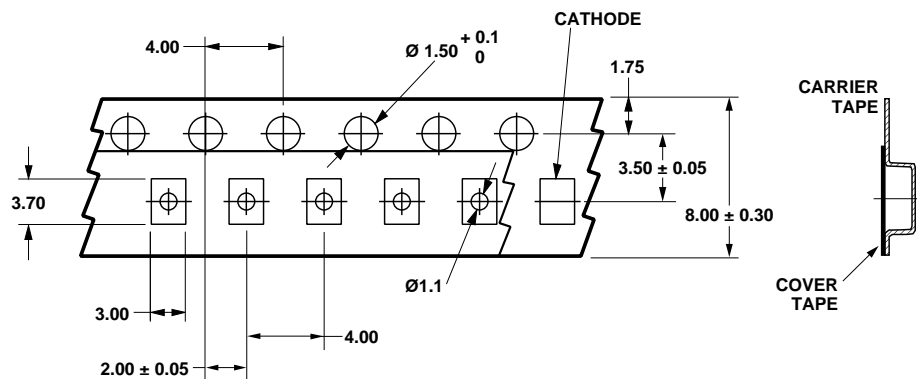
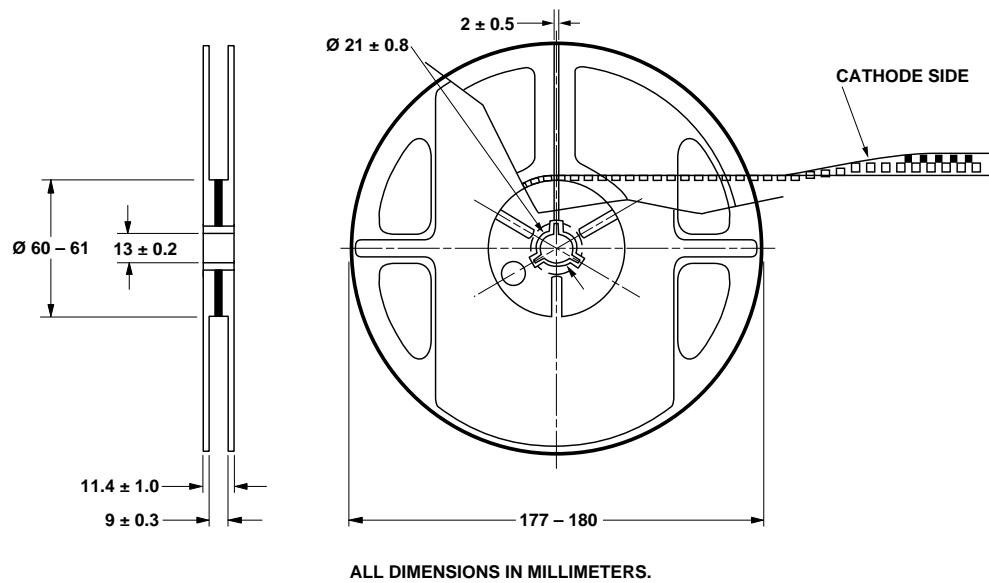


Figure 9. Tape and Reel Dimensions.



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**LumiLeds Lighting:
The Revolution of Lighting.**

LumiLeds Lighting is a joint venture between Philips Lighting and Agilent Technologies.

Agilent Technologies, an \$8 billion startup, is the result of the strategic realignment of Hewlett-Packard, producer of the world's brightest red and amber LEDs, as well as state-of-the-art, high-brightness LEDs in blue, green, white and other colors.

Philips is a global leader in developing, manufacturing and marketing innovative lighting products worldwide.

LumiLeds Lighting is changing the future of lighting. In the next century, LED-based lighting will quickly replace conventional lighting for a wealth of commercial, industrial, institutional and consumer applications. By combining the lighting expertise of Philips and the LED technology strength of Agilent, our products will bring irresistible value to lighting solutions of all kinds. LumiLeds Lighting will reduce waste and power consumption worldwide by developing long-lasting, energy-efficient products.

Lumileds Lighting

An Agilent Technologies & Philips Lighting Joint Venture

www.lumileds.com

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